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### NPN General Purpose Transistor

The MMBT2222AM3T5G device is a spin-off of our popular SOT-23 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-723 surface mount package. This device is ideal for low-power surface mount applications where board space is at a premium.

#### Features

- Reduces Board Space
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector – Base Voltage	V <sub>CBO</sub>	75	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	600	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P <sub>D</sub>	265 2.1	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	470	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	640 5.1	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	195	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

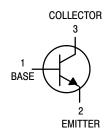
1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.

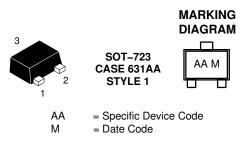
2. Alumina =  $0.4 \times 0.3 \times 0.024$  in. 99.5% alumina.



#### **ON Semiconductor®**

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#### ORDERING INFORMATION

	Device	Package	Shipping <sup>†</sup>
MMBT22	22AM3T5G	SOT-723 (Pb-Free)	8000/Tape & Reel
NSVMM	3T2222AM3T5G	SOT-723 (Pb-Free)	8000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Charact	eristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (I <sub>C</sub> =	10 mAdc, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	40	-	Vdc
Collector-Base Breakdown Voltage (I <sub>C</sub> = 10	$\mu$ Adc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	75	-	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10 \mu$	Adc, $I_{\rm C} = 0$ )	V <sub>(BR)EBO</sub>	6.0	-	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 60 Vdc, V <sub>EB</sub>	<sub>(off)</sub> = 3.0 Vdc)	I <sub>CEX</sub>	-	10	nAdc
Collector Cutoff Current $(V_{CB} = 60 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 60 \text{ Vdc}, I_E = 0, T_A = 125^{\circ}\text{C}$	)	I <sub>CBO</sub>		0.01 10	μAdc
Emitter Cutoff Current ( $V_{EB} = 3.0$ Vdc, $I_C = 0$	))	I <sub>EBO</sub>	-	100	nAdc
Base Cutoff Current (V <sub>CE</sub> = 60 Vdc, V <sub>EB(off)</sub>	= 3.0 Vdc)	I <sub>BL</sub>	-	20	nAdc
ON CHARACTERISTICS					1
$ \begin{array}{l} \text{DC Current Gain} \\ (I_{C}=0.1 \text{ mAdc}, \text{ V}_{CE}=10 \text{ Vdc}) \\ (I_{C}=1.0 \text{ mAdc}, \text{ V}_{CE}=10 \text{ Vdc}) \\ (I_{C}=10 \text{ mAdc}, \text{ V}_{CE}=10 \text{ Vdc}) \\ (I_{C}=10 \text{ mAdc}, \text{ V}_{CE}=10 \text{ Vdc}, \text{ T}_{A} \text{ c}) \\ (I_{C}=150 \text{ mAdc}, \text{ V}_{CE}=10 \text{ Vdc}) (\text{N}) \\ (I_{C}=150 \text{ mAdc}, \text{ V}_{CE}=1.0 \text{ Vdc}) (\text{N}) \\ (I_{C}=500 \text{ mAdc}, \text{ V}_{CE}=10 \text{ Vdc}) (\text{N}) \\ \end{array} $	lote 3) Note 3)	h <sub>FE</sub>	35 50 75 35 100 50 40	- - 300 -	-
	3)	V <sub>CE(sat)</sub>		0.3 1.0	Vdc
$\begin{array}{l} \text{Base-Emitter Saturation Voltage (Note 3)} \\ (I_{C} = 150 \text{ mAdc}, I_{B} = 15 \text{ mAdc}) \\ (I_{C} = 500 \text{ mAdc}, I_{B} = 50 \text{ mAdc}) \end{array}$		V <sub>BE(sat)</sub>	0.6	1.2 2.0	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain – Bandwidth Product (Note 4 (I <sub>C</sub> = 20 mAdc, V <sub>CE</sub> = 20 Vdc, f =		f <sub>T</sub>	300	_	MHz
Output Capacitance ( $V_{CB} = 10$ Vdc, $I_E = 0$ , f	= 1.0 MHz)	C <sub>obo</sub>	-	8.0	pF
Input Capacitance ( $V_{EB} = 0.5 \text{ Vdc}, I_C = 0, f = 0$	= 1.0 MHz)	C <sub>ibo</sub>	-	25	pF
Input Impedance $(I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = (I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = $	1.0 kHz) 1.0 kHz)	h <sub>ie</sub>	2.0 0.25	8.0 1.25	kΩ
Voltage Feedback Ratio $(I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = (I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 10  Vdc$		h <sub>re</sub>		8.0 4.0	X 10-4
$      Small - Signal Current Gain \\ (I_C = 1.0 mAdc, V_{CE} = 10 Vdc, f = \\ (I_C = 10 mAdc, V_{CE} = 10 Vdc, f = $		h <sub>fe</sub>	50 75	300 375	-
Output Admittance $(I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = (I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f $	1.0 kHz) 1.0 kHz)	h <sub>oe</sub>	5.0 25	35 200	μmhos
Collector Base Time Constant ( $I_E = 20$ mAdc, $V_{CB} = 20$ Vdc, f = 1	31.8 MHz)	rb, C <sub>c</sub>	_	150	ps
Noise Figure (I <sub>C</sub> = 100 $\mu$ Adc, V <sub>CE</sub> = 10 Vdc, R <sub>S</sub> = 1.0 kΩ, f = 1.0 kHz)		NF	-	4.0	dB
SWITCHING CHARACTERISTICS					1
Delay Time	(V <sub>CC</sub> = 30 Vdc, V <sub>BE(off)</sub> = -0.5 Vdc,	t <sub>d</sub>	_	10	ns
Rise Time	$I_{\rm C} = 150 \text{ mAdc}, I_{\rm B1} = 15 \text{ mAdc})$	t <sub>r</sub>	-	25	
		+		+	
Storage Time	(V <sub>CC</sub> = 30 Vdc, I <sub>C</sub> = 150 mAdc,	ts	-	225	

3. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%. 4. f<sub>T</sub> is defined as the frequency at which |h<sub>fe</sub>| extrapolates to unity.

#### SWITCHING TIME EQUIVALENT TEST CIRCUITS

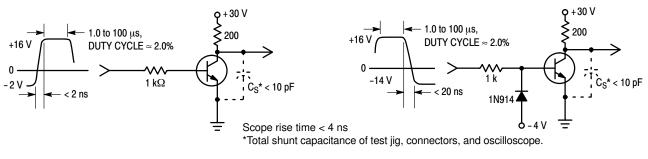
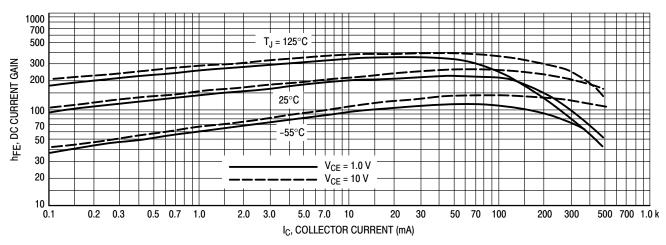
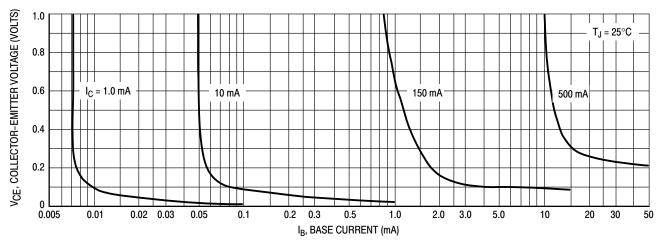




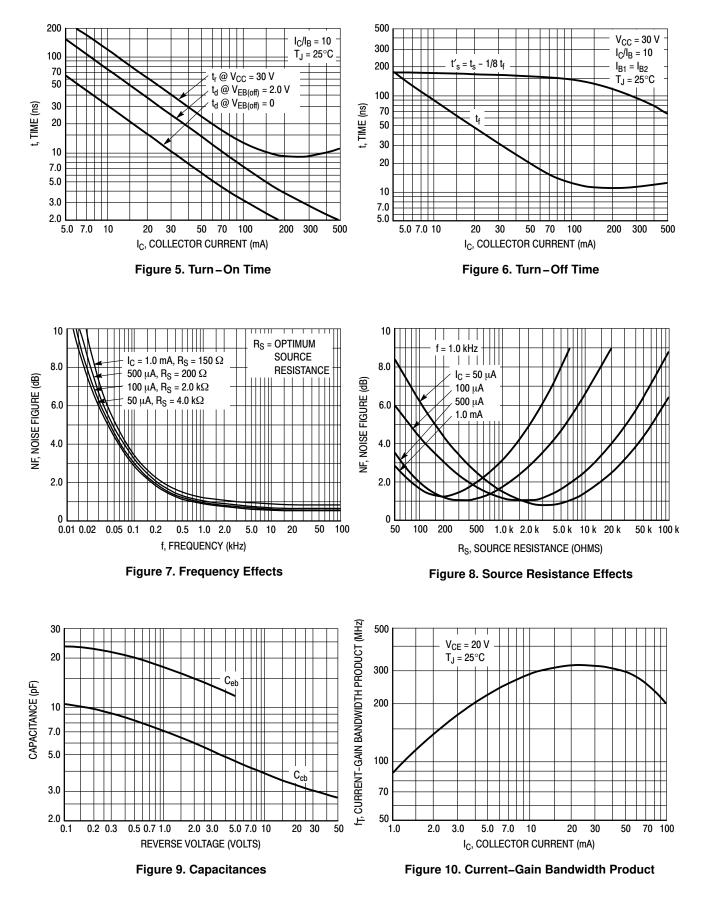
Figure 2. Turn-Off Time











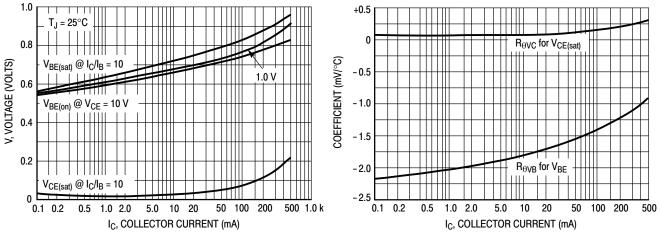
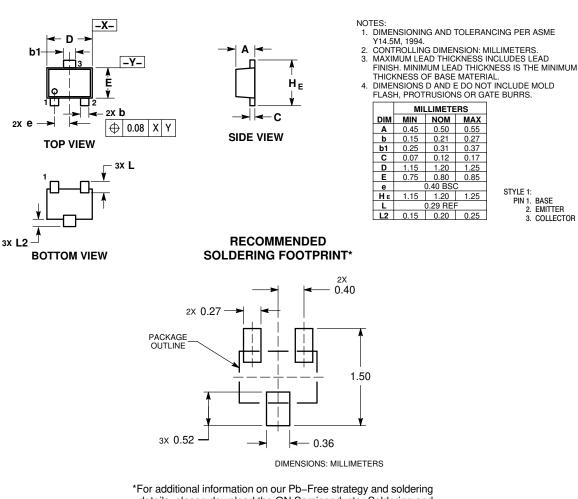


Figure 11. "On" Voltages

Figure 12. Temperature Coefficients

#### PACKAGE DIMENSIONS

SOT-723 CASE 631AA ISSUE D



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